/VI/IXI/VI

Complete, +5V-Powered, Isolated, Dual RS-232 Transceiver Module

General Description

The MAX252 complete, electrically-isolated, dual RS-232 transmitter/receiver system requires no external components. By combining many functions in one package, the cost and complexity of an isolated digital interface are greatly reduced.

A single +5V supply powers both sides of the interface. Transceivers, optocouplers, and a transformer in one low-cost package provide a complete interface up to 9600 bits/sec. Additional pins provide low-power shutdown and a high-impedance state for both transmitter outputs.

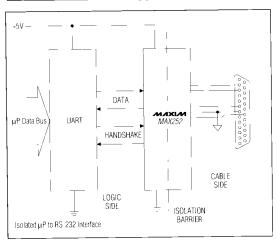
The MAX252A withstands 130V_{RMS} (continuous), 1260V_{RMS} (1 min.) or 1520V_{RMS} (1 sec.) and is intended for applications where very high transient voltages, differential ground potentials or noise may be encountered. The MAX252A is UL recognized. The MAX252B is intended for less stringent applications and is rated for 500V_{RMS} (1 min.) or 600V_{RMS} (1 sec.).

Receivers and line drivers (transmitters) meet EIA RS-232D and CCITT V.28 specifications. The MAX252 is supplied in 40-pin plastic DIP packages in commercial (0°C to +70°C) and extended (-40°C to +85°C) temperature ranges.

Applications

High-Noise Environments Automatic Test Equipment Differential Ground Potentials

Typical Application



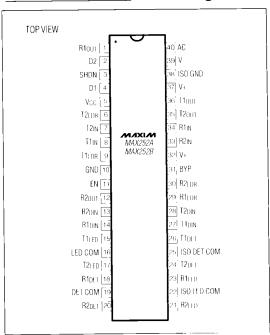
Features

- ♦ Isolated Data Interface
- ♦ No External Components
- ♦ Single +5V Supply
- ♦ 50µW Low-Power Shutdown
- ♦ Two Transmitters and Two Receivers
- ♦ UL Recognized (MAX252A) File E118032 to UL1577

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX252ACHL	0°C to +70 C	40 Plastic Module
MAX252BCHL	0°C to +70°C	40 Plastic Module
MAX252AEHL	-40°C to +85°C	40 Plastic Module
MAX252BEHL	-40°C to +85°C	40 Plastic Module

Pin Configuration



MAXIM

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ABSOLUTE MAXIMUM RATINGS

Voltages with respect to GND (pin 10) Supply Voltage, VCC	LED Forward Continuous Current (pins 15, 17, 21, 23) 30mA Power Dissipation Plastic DIP (derate 10mW/C above +70 C) 650mW Operating Temperature Ranges: MAX252ACHL/BCHL 0°C to +70°C MAX252AEHL/BEHL40°C to +85°C Storage Temperature Range65°C to +150°C Lead Temperature (soldering, 10 sec.) +300°C
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Strosses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(VCC = +5V \pm 10\%, TA = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS
ISOLATION (Note 1)				7		1	
		T _A = +25°C MAX252A	1sec	1520			
	Viso		1 min. (Note 2)	1260		1	
Test Voltage			Continuous (Note 2)	130			VRMS
		MAX252B	1 sec	600			
			1 min. (Note 2)	500			1
Leakage Current		10 sec., V _{ISO} =	: 500V _{RMS} , 60Hz,		10	50	μARMS
Isolation Resistance		T _A = +25°C 500V _{DC}		1_	10 ¹⁰		Ω
Capacitance	1	OV			10		pF
POWER SUPPLY				T			
O time Committee Contract	100	T _A = +25 °C. SHDN = 0V	T1 _{IN} , T2 _{IN} , R1 _{IN} . R2 _{IN} = VCC	-	60	90	I mA
Operating Supply Current	l cc _		$T1_{IN}, T2_{IN}, R1_{IN}, R2_{IN} = 0$		8	15	
Shutdown Supply Current	Ics	SHDN = VCC	T _A = +25°C		1	10	μA
EN, SHDN Input Current	IEN. ISHDN	Input = GND to	> Vcc		0.001	1	μA
TTL/CMOS INPUTS/OUTPUTS							
TTL/CMOS Input Pull-Up Current	IP.	VIN = 0V			4	20	μA
TTL/CMOS Output Voltage Low	Vol	IOUT = 3.2mA		-1 -		0.4	V
TTL/CMOS Output Voltage High	Voн	10UT = -1.0mA	<u> </u>	3.5			, V
Input Logic Threshold High	VIH -	T1 _{IN} , T2 _{IN} . EN	. SHDN		1.8	2.4	V
Input Logic Threshold Low	VIL	T1 _{IN} , T2 _{IN} , EN	, SHDN	0.8	1.3		V
Input Hysteresis		T1 _{IN} , T2 _{IN}		+ -	0.5		
Leakage Current, Output Disabled	IL	T1 _{IN} , T2 _{IN} ; EN	or SHDN = Vcc	<u> </u> _		10	μΑ
Input Capacitance	Cin	T1 _{IN} , T2 _{IN}		_	5		pF

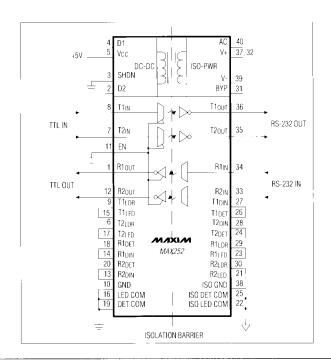
Note 1: Pins 1-20 tied together and pins 21-40 tied together. Note 2: Value derived from 1 sec. test.

ELECTRICAL CHARACTERISTICS (continued)

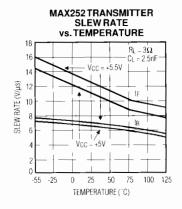
 $(VCC = +5V \pm 10\%, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$

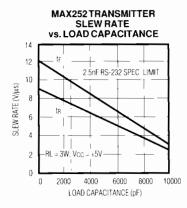
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RS-232 CHARACTERISTICS						
RS-232 Output Voltage Swing	VPP	T10UT, T20UT, $R_L = 3k\Omega$ to ISO	±5	±7.2		V
RS-232 Output Leakage Current		V+ = V- = 0V or SHDN = VCC, T1 _{OUT} , T2 _{OUT} = ±15V	-100		+100	μΑ
RS-232 Input Threshold High		R1 _{IN} , R2 _{IN}		1.8	3.0	V
RS-232 Input Threshold Low		R1 _{IN} , R2 _{IN}	0.6	1.2		V
RS-232 Input Hysteresis		R1 _{IN} , R2 _{IN}		0.6		V
RS-232 Input Resistance		R1 _{IN} , R2 _{IN} , T _A = +25°C	3		7	kΩ
Transmitter Output Slew Rate	SR	$R_L = 3k\Omega$, $C_L = 2500pF$ Sample Tested Measured from +3v to -3V or -3V to +3V		3	30	V/µs
Dana anatina Dalau	tR	RS-232 to TTL		24	·	
Propagation Delay	tT	TTL to RS-232		20		μs
Transmission Rate		Sample Tested $ \begin{array}{l} \text{R}_{L} = 3k\Omega \\ \text{C}_{L} = 2500 \text{pF} \end{array} $	9600	19200		Bits/sec

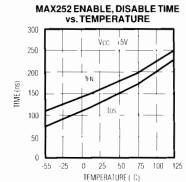
Typical Operating Circuit

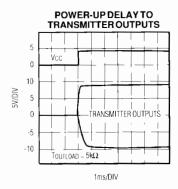


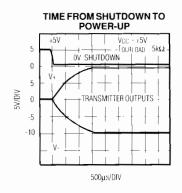
Typical Operating Characteristics











Pin Description

PIN#	NAME	FUNCTION
1	R1out	Receiver #1 Output; TTL/CMOS logic levels
2	D2	Internal Connection. Leave this pin unconnected. Do not ground.
3	SHDN	Shutdown. When high, turns off the oscillator and disconnects driver inputs. Ground for normal operation.
4	D1	Internal Connection. Leave this pin unconnected. Do not ground.
5	Vcc	+5V Supply Voltage
6	T2LDR	Transmitter #2 LED Driver
7	T2IN	Transmitter #2 Input; TTL/CMOS logic levels
8	T1IN	Transmitter #1 Input; TTL/CMOS logic levels
9	T1LDR	Transmitter #1 LED Driver
10	GND	Ground
	EN	Output Enable. If High, T1LDR, T2LDR, R1OUT, and R2OUT go to high-impedance state. Ground for normal operation.
12	R2OUT	Receiver #2 Output; TTL/CMOS logic levels
13	R2DIN	Receiver #2 Detector Input
14	R1 _{DIN}	Receiver #1 Detector Input
15	T1 _{LED}	T1 LED Anode Input
16	LED COM	Common T1 _{LED} , T2 _{LED} Cathode. Tie to Ground.
17	T2LED	T2 LED Anode Input
18	R1 _{DET}	R1 Photodiode Cathode Output
19	DET COM	Common R1DET, R2DET Anode. Tie to Ground.
20	R2DET	R2 Photodiode Cathode Output

		<u> </u>	
PIN#	NAME	FUNCTION	
21	R2LED	R2 LED Cathode Input	
22	ISO LED COM	Common R1 _{LED} , R2 _{LED} Cathode. Tie to Isolated Ground.	
23	R1LED	R1 LED Cathode Input	
24	T2DET	T2 Photodiode Anode Output	
25	ISO DET COM	Common T1DET, T2DET LED Anode. Tie to Isolated Ground.	
26	T1DET	T1 Photodiode Anode Output	
27	T1DIN	Transmitter #1 Detector Input	
28	T2 _{DIN}	Transmitter #2 Detector Input	
29	R1 _{LDR}	Receiver #1 LED Driver	
30	R2LDR	Receiver #2 LED Driver	
31	ВҮР	Internal Connection. Leave this pin unconnected. Do not ground.	
32	V+	Isolated Positive Supply	
33	R2IN	RS-232 Receiver #2 Input	
34	R1 _{IN}	RS-232 Receiver #1 Input	
35	T20UT	RS-232 Transmitter #2 Output	
36	T1OUT	RS-232 Transmitter #1 Output	
37		Isolated Positive Supply	
38	ISO GND	Isolated Ground	
39		Isolated Negative Supply Voltage	
40	AC	Internal Connection. Leave this pin unconnected. Do not ground.	

Isolation Applications

The MAX252 is intended for industrial communications and control applications where voltage transients, differential ground potentials or high noise may be encountered. The MAX252A withstands $130V_{RMS}$ (continuous), $1260V_{RMS}$ (1 min.) or $1520V_{RMS}$ (1 sec.). For less stringent applications, the MAX252B is rated at $500V_{RMS}$ (1 min.) or $600V_{RMS}$ (1 sec.). For applications requiring higher isolation ratings or transmission rates greater than 9600 baud, Maxim recommends the MAX250 and MAX251 device set that uses external optocouplers and transformer.

Figure 1 shows the typical interconnection for a complete 9600 bits/sec. transceiver. Important layout considerations include:

- * For maximum isolation, the isolation line through the center of Figure 1 should not be breached; connections from each side should be kept separate.
- * Optocoupler outputs (pins 18, 20, 24, and 26) are high-impedance nodes, so connecting traces should be

R1out 40 AC 39, V SHDN 8 ISO GND 37 V. D1 T10UT Vcc T2_{0U}T T2cor R1_{IN} T2_{IN} MAXIM T1_{IN} R21N MAX252 T1LDR 9 2 V+ GND 31 RYP EN R2LDR R1L DR R20UT J R2DIN T2DIN R1DIN II T1_{DIN} T1LED T10ET LED COM ISO DET COM T2LFD T2DET R1DET 1 R1LED ISO LED COM DET COM R2DEL G R2i ED \Leftrightarrow ISOLATION BARRIER

Figure 1. Typical Interconnections

as short as possible to minimize stray capacitance and maximize data transfer rate; shunt capacitance seen by each pin should not exceed 10pF.

The MAX252 pin out enables optimal printed circuit board layout by minimizing interconnect lengths and cross-overs. Figure 2 shows the preferred layout, which is strongly recommended for 9600 bits/sec. applications. Note the position of the ground traces, particularly the protection of pin 20 by the wraparound from pin 19.

Isolation Example

Figure 3 illustrates how to isolate an existing RS-232 interface by inserting a MAX252 and MAX233 in series. Both devices invert while translating RS-232 to TTL and TTL to RS-232 levels. Since there is no net inversion, the circuit functions like two plain pieces of wire, but with 1520V_{RMS} (at 1 sec.) isolation between the ports.

Detailed Description

The MAX252 contains two integrated circuits, four optocouplers, four capacitors, two diodes, and a small transformer. Together, these provide a complete, isolated, dual RS-232 transmitter and receiver. The non-isolated or logic side of the interface transfers logic signals to and from the optocouplers, while the isolated or cable side transfers data between the optocouplers and RS-232

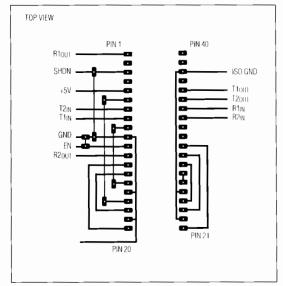


Figure 2. Preferred Layout

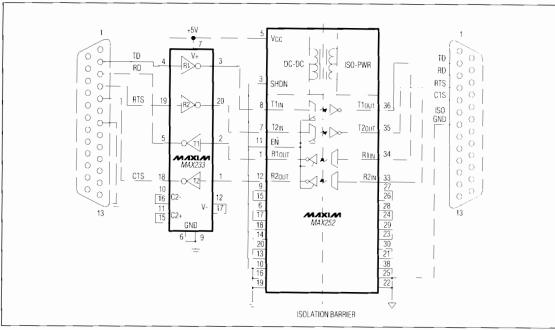


Figure 3. RS-232 Isolation Adapter from a Single +5V Supply

transmitters (line drivers) and receivers. The MAX252 also contains an isolation transformer and drive circuitry to supply power to the isolated side of the interface.

On the logic side of the MAX252 are four identical non-inverting drivers whose outputs may be used either as optocoupler LED drivers or as TTL/CMOS logic outputs. Each driver input (T1_{IN}, T2_{IN}, R1_{DIN}, R2_{DIN}) has a weak 4µA internal pull-up current source, and 0.5V hysteresis to improve noise rejection; logic thresholds for the driver inputs conform to standard TTL/CMOS specifications.

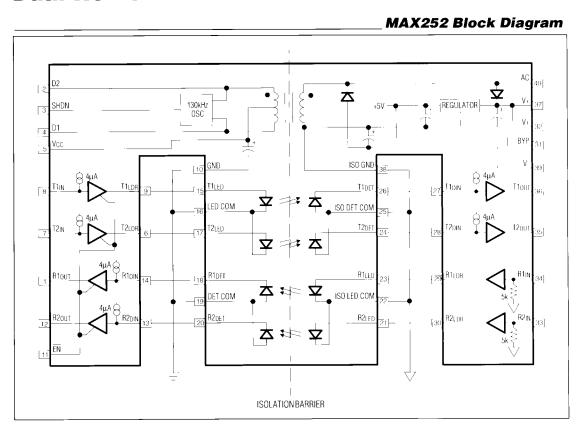
The RS-232 side of the interface includes two line drivers and receivers along with circuitry to translate these levels to optocoupler signals. The RS-232 inputs (R1_{IN}, R2_{IN}) and outputs (T1_{OUT}, T2_{OUT}) conform to EIA RS-232D and CCITT V.28 specifications. The inputs to the RS-232 line drivers (T1_{DIN}, T2_{DIN}), which are normally strapped to the internal optoisolators, are TTL/CMOS compatible.

Also included are an OUTPUT ENABLE control (EN) and a SHUTDOWN pin (SHDN). EN places all driver outputs in a high-impedance state when driven high. SHDN, when pulled high, performs the following functions:

- 1) Turns off the 130kHz oscillator, removing power from the RS-232 side of the interface.
- 2) Places T1_{OUT} and T2_{OUT} in a high-impedance state.
- 3) Disables the 4µA pull-up currents at the logic-side driver inputs (T1_{IN}, T2_{IN}, R1_{DIN}, R2_{DIN}).
- 4) Resets logic-side driver outputs (T1_{LDR}, T2_{LDR}, R1_{OUT}, R2_{OUT}) to low.
- 5) Reduces power consumption to 50µW.

Module Product Reliability

For reliability data on Maxim's Module Product Line, see Reliability Report RR-3A.



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